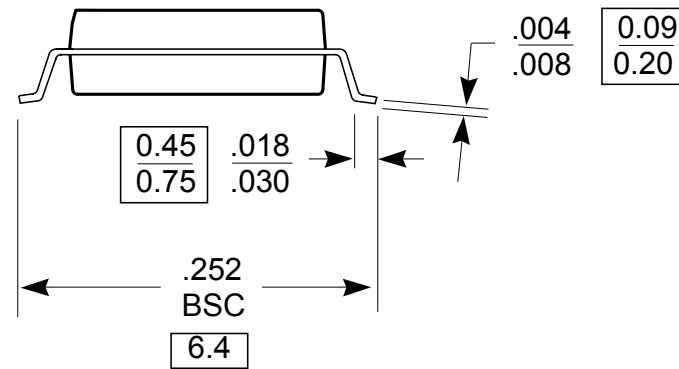
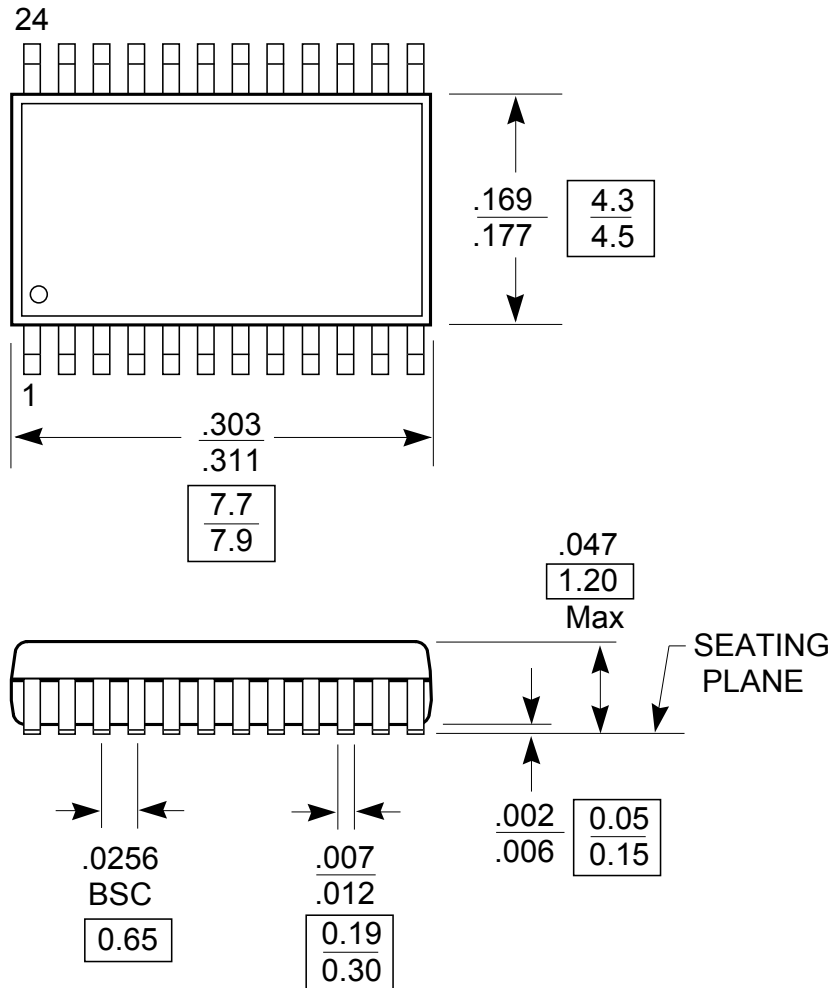


DOCUMENT CONTROL NO.
PD - 1312

REVISION: E
DATE: 03/09/05



Note:

1. Package Outline Exclusive of Mold Flash and Metal Burr
2. Controlling dimensions in millimeters
3. Ref: JEDEC MO-153F/AD



Pericom Semiconductor Corporation
3545 N. 1st Street, San Jose, CA 95134
1-800-435-2335 • www.pericom.com

DESCRIPTION: 24-Pin, 173-Mil Wide, TSSOP

PACKAGE CODE: L